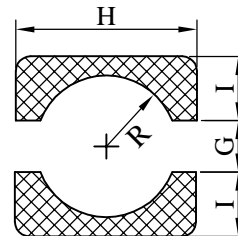
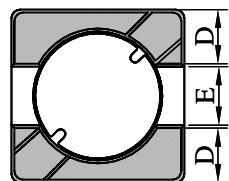
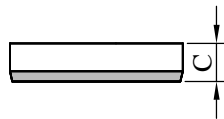
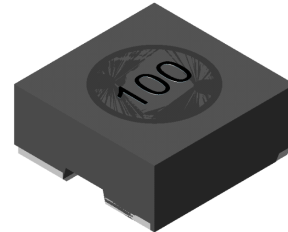
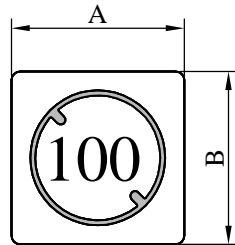


SPECIFICATION FOR APPROVAL

REF. :

PROD. NAME	Shielded SMD Power Inductor	ABC'S DWG NO.		SH3018□□□□L□-□□□		
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I . Configuration and dimensions :



(PCB Pattern)

Unit : m/m

A	B	C	D	E	G	H	I	R
3.80 ±0.3	3.80 ±0.3	1.65 ±0.15	1.30 typ.	1.20 typ.	1.10 ref.	4.30 ref.	1.60 ref.	1.30 ref.

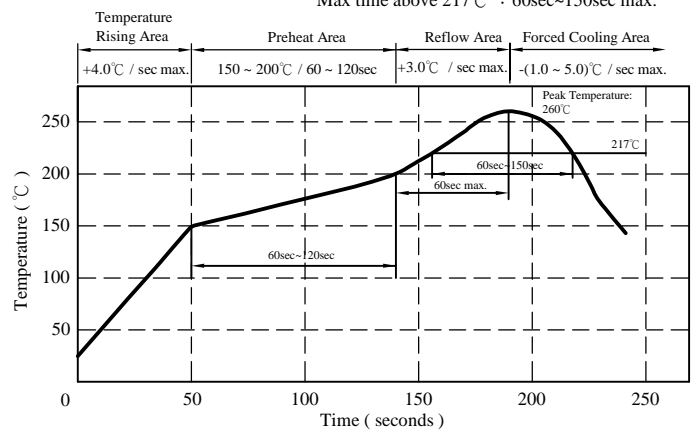
II . Description :

- a . Ferrite drum core construction.
- b . Magnetically shielded.
- c . Enamelled copper wire : H class
- d . Product weight : 0.105 g (ref.)
- e . Moisture sensitivity Level 1
- f . Products comply with RoHS' requirements
- g . Halogen free available

III . General specification :

- a . Storage temp. : -40°C ----+125°C
- b . Operating temp. : -40°C ----+125°C
(Temp. rise included)
- c . Resistance to solder heat : 260°C .10 secs.

Peak Temp : 260°C max.
 Max. Peak Temp - 5°C : 30sec max.
 Max time above 217°C : 60sec~150sec max.



SPECIFICATION FOR APPROVAL

REF. :

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IV . Electrical characteristics :

DWG No.	Inductance (μ H)	SRF (MHz) typ.	RDC (m Ω)		Irms (mA) max.	Isat (mA) typ.
			max.	typ.		
SH30181R5YL□-□□□	1.5 \pm 30%	118	47	35	1750	1550
SH30182R5YL□-□□□	2.5 \pm 30%	79	58	45	1450	1250
SH30183R6YL□-□□□	3.6 \pm 30%	79	85	65	1380	1100
SH30184R7YL□-□□□	4.7 \pm 30%	61	105	85	1200	900
SH30186R8YL□-□□□	6.8 \pm 30%	46	156	125	850	750
SH3018100YL□-□□□	10.0 \pm 30%	39	205	165	740	560
SH3018150YL□-□□□	15.0 \pm 30%	31	285	230	620	450
SH3018220YL□-□□□	22.0 \pm 30%	29	450	360	510	360
SH3018330YL□-□□□	33.0 \pm 30%	24	660	545	420	320
SH3018470YL□-□□□	47.0 \pm 30%	21	1000	800	390	250
SH3018680YL□-□□□	68.0 \pm 30%	13	1450	1200	320	220
SH3018101YL□-□□□	100.0 \pm 30%	10	2400	2050	250	180

- 1). □ : Packaging information : □ Code
- 2). "-□□□" : Reference code
- 3). Electrical specifications at 25°C
- 4). Inductance Test Condition. : 100kHz / 0.1V
- 5). Irms base on Temp. rise 30°C max.
- 6). Isat base on Δ L/L0A = 35% typ.

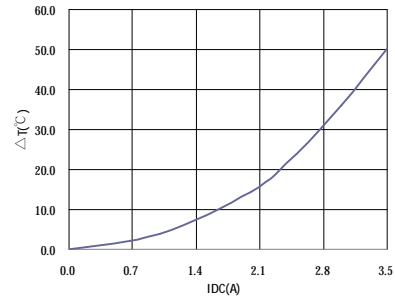
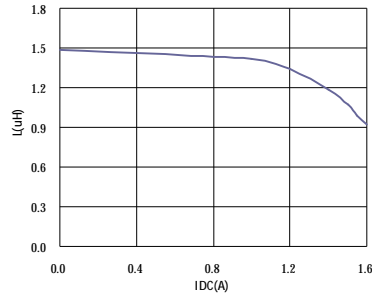
SPECIFICATION FOR APPROVAL

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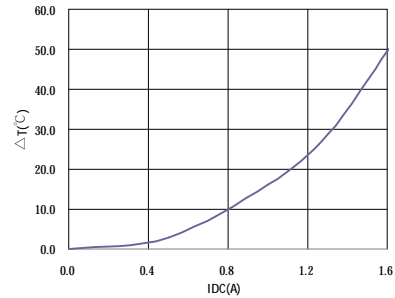
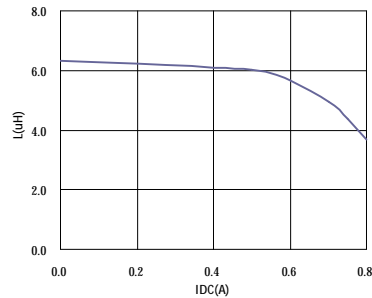
PROD. NAME	Shielded SMD Power Inductor	ABC'S DWG NO.	SH3018□□□□L□-□□□		
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V . Curve :

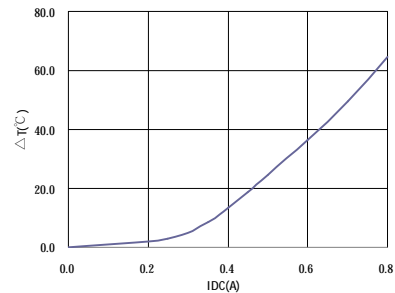
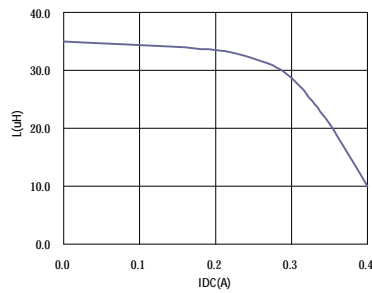
SH30181R5YL□



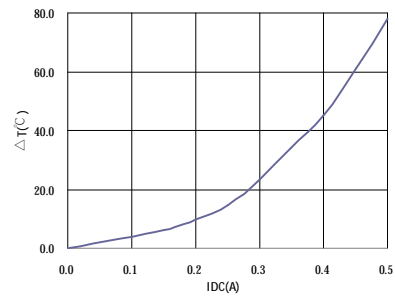
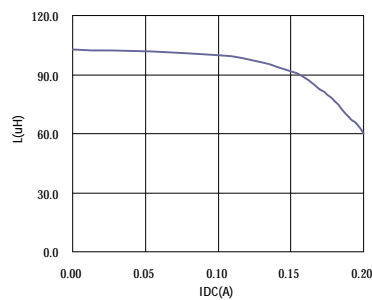
SH30186R8YL□



SH3018330YL□



SH3018101YL□



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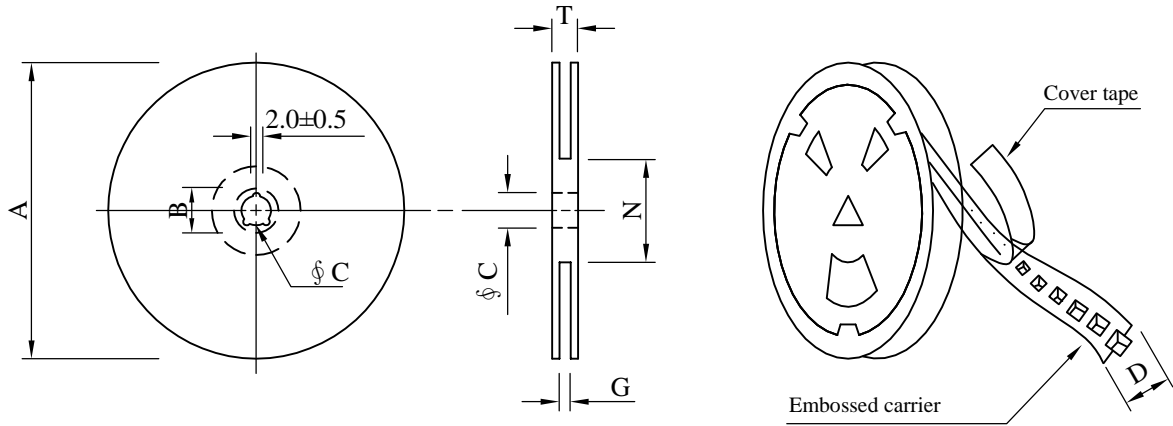
SPECIFICATION FOR APPROVAL

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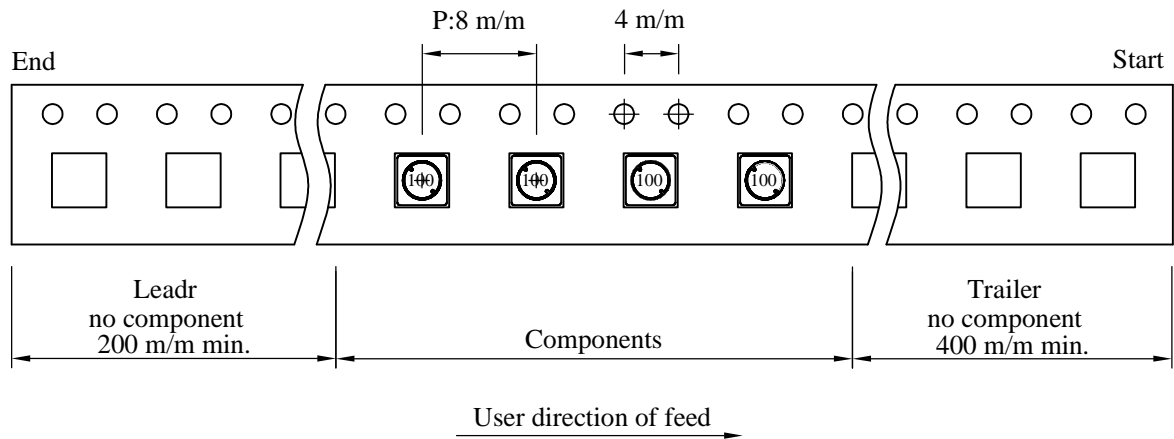
PROD. NAME	Shielded SMD Power Inductor	ABC'S DWG NO.	SH3018□□□□L□-□□□		
		REV.	20150803-F	PAGE	4

VI . Packaging information :

(1) Configuration



※Carrier tape width : D



(2) Dimensions

Unit:m/m

Style	A	B	C	D	G	N	T
07 - 12	178	21±0.8	13	12	15 ⁺⁰	50 ⁻⁰	16.5

(3) Q'TY & G.W. Per package

Code	Inner : Reel			Outer : Carton		
	Q'TY (pcs)	G.W. (gw)	Style	Q'TY (pcs)	G.W. (Kg)	Size (cm)
B,C	1,000	210	07 - 12	40,000	9.9	42 x 41 x 24

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SPECIFICATION FOR APPROVAL

REF. :

PROD. NAME	Shielded SMD Power Inductor	ABC'S DWG NO.	SH3018□□□□L□-□□□		
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VII . Reliability test :

Item	Reference documents	Test Condition	Test Specification
1.High Temperature Exposure	MIL-STD-202 Method 108	1.Temperature: 125±2℃ 2.Time:96±2 hours.	1.No mechanical or electrical damage. 2.Inductance shall not change more than ±20%.
2.Temperature Cycling	JESD22-A 104	1.Temperature: -40℃ ~ +125℃ 2.Number of cycle:100 cycle 3.Dwell time:30 minutes	1.No mechanical or electrical damage. 2.Inductance shall not change more than ±20%.
3.Biased Humidity Test	MIL-STD-202 Method 103	1.Temperature : 85±2 ℃ 2.Humidity: 85% RH. 3.Time:96±2 Hours	1.No mechanical or electrical damage. 2.Inductance shall not change more than ±20%.
4.Operational Life	JESD22-A 108	1.Temperature: 125℃ (Temp. rise included) 2.Time:96±2 hours. 3.Rated current	1.No mechanical or electrical damage. 2.Inductance shall not change more than ±20%.
5.External Visual	JESD22-B 101 & MIL-STD-883 Method 2009	Inspect product constructions, marking and workmanship.	1.No pollution on the surface of products. 2.Clear marking. 3.No crack.
6.Physical Dimensions	JESD22-B 100	Verify physical dimensions to the applicable product detail specification.	Per product specification standard
7.Resistance to solvents	MIL-STD-202 Method 215	Immerse into solvent for 3±0.5 minutes & brush 10 times for 3 cycles.	1.No body change in appearance. 2.No marking blurred. 3.Inductance shall not change more than ±20%.
8.Vibration Test	MIL-STD-202 Method 204	1.Frequency and Amplitud : 10-2000-10 Hz, 1.5 mm. 2.Direction:X, Y, Z 3.Test duration:2 hours for each direction, 6 hours in total.	1.No mechanical or electrical damage. 2.Inductance shall not change more than ±20%.
9.Resistance To Soldering Heat Test	MIL-STD-202 Method 210 & J-STD020D.1	1.Highest temperature : 260±5℃. 2.Time (temp. ≥ 217℃) : 60~150 Second. 3.IR reflow times : 3 times.	1.No mechanical or electrical damage. 2.Inductance shall not change more than ±20%.
10.Saturation Current	JIS C 6436 & User SPEC.	1.Applied rated current for 5 second. 2.Saturation current	Inductance shall not drop more than 35% typ.
11.Over load	JIS C 6436 & User SPEC.	1.Applied one and half rated current for a period of 5 minutes. 2.Rated current	No electrical or mechanical damage
12.Temperature Rise Current	JIS C 6436 & User SPEC.	1.Applied rated current for 10 minutes. 2.Temperature measure by digital surface thermometer. 3.Irms current	Surface temperature rise is less than 30℃ max.
13.Solderability Test	J-STD-002 & JESD22-B 102	1.Baking in pre-testing : 150±5℃ / 16Hours±30 min. 2.Peak temperature : 240±5℃ 3.Time (temp. ≥ 217℃) : 60~150 second. 4.IR reflow times : 1 times.	More than 95% soldering coverage min on terminations.
14.Electrical Characteriazation	MIL-STD-202 Method 304 & User SPEC.	1.Operating temperature : -40℃~125℃ 2.Room temperature : 25℃.	1.No mechanical or electrical damage. 2.Inductance shall not change more than ±20%.
15.Drop	CNS-C6354 & GB/T 2423.8	1.Products shall be mounted on SPEC. PCB and dropped down from a height of 1m 2.Drop total time : 6 time (Every side of sample drop 2 time)	1. Adhesion on PCB shall be enough. 2. Product appearance shall not break. 3. No electrical damage.
16.Terminal Strength Test	IEC 60068-2-21	1.Apply push force to samples mounted on PCB. 2.Force of 1.8 kg for 60±1 seconds.	After test, inductors shall be no mechanical damage.

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